

Electronic Patent Application Fee Transmittal

Application Number:	10562235			
Filing Date:				
Title of Invention:	Manufacturing method of semiconductor wafer and semiconductor wafer manufactured by this method			
First Named Inventor/Applicant Name:	Syouji Nogami			
Filer:	Jules Edward Goldberg			
Attorney Docket Number:	JG-SU-5224/500577.20073			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Late filing fee for oath or declaration	1051	1	130	130
Petition:				
Patent-Appeals-and-Interference:				
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Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Total in USD (\$)				130